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(12) **United States Design Patent** (10) **Patent No.:** **US D937,792 S**  
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(54) **CIRCUIT BOARD**

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(\*\*) Term: **15 Years**

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(52) **U.S. Cl.**  
USPC ..... **D13/182**

(58) **Field of Classification Search**

USPC ..... D13/182; 361/748, 752, 760, 761, 807, 361/808, 736, 719, 720; 174/250, 253, 174/255, 68.1; 363/144, 147  
CPC ..... H05K 3/30; H05K 3/301; H05K 3/284; H05K 3/303; H05K 1/18; H05K 1/181; H05K 1/182; H05K 1/183; H05K 1/185; H05K 1/00; H05K 7/1417; H05K 7/02; H05K 7/12; H05K 7/06; H01L 2924/14  
See application file for complete search history.

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(57) **CLAIM**

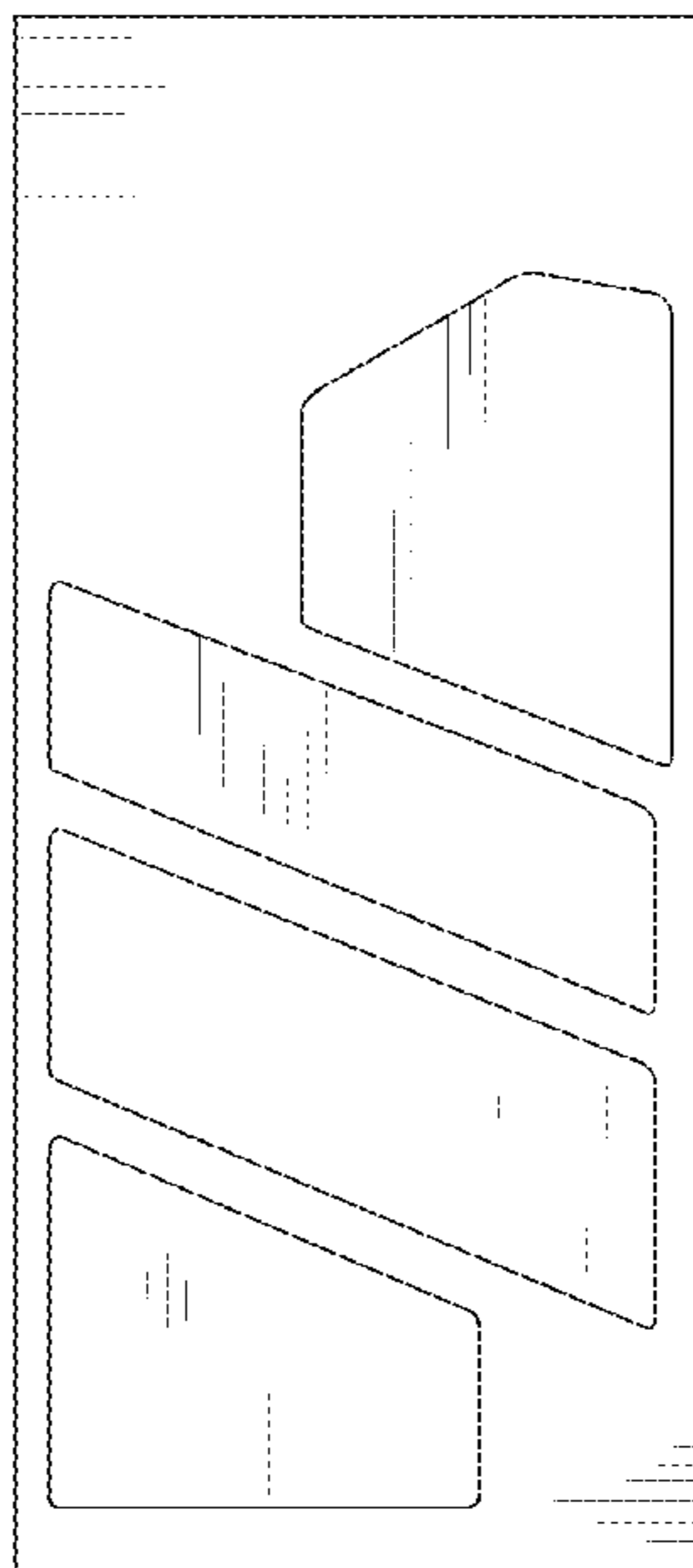
The ornamental design for a circuit board, as shown and described.

**DESCRIPTION**

The sole FIGURE is a front elevational view of a circuit board, showing our new design.

All surfaces not shown form no part of the claimed design.

**1 Claim, 1 Drawing Sheet**



(56)

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